506088169 06/03/2020

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6134887

Ŀ	SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT				
	NATURE OF CONVEYANCE:	Corrective Assignment to correct the ADDRESS OF THE ASSIGNEE previously recorded on Reel 052791 Frame 0133. Assignor(s) hereby confirms the ADDRESS IS: NO. 68 LIANHE ROAD CHEMICAL INDUSTRY PARK, SHANGHAI, CHINA 201507.				

# **CONVEYING PARTY DATA**

Name	<b>Execution Date</b>	
HONG ZHANG	05/14/2020	
FEI TENG	05/14/2020	
JIANMIN YANG	04/27/2020	
ZHISHENG WANG	04/26/2020	
YI JHEN HUANG	05/14/2020	

# **RECEIVING PARTY DATA**

Name:	EVONIK SPECIALTY CHEMICALS (SHANGHAI) CO., LTD.				
Street Address:	NO. 68 LIANHE ROAD				
Internal Address:	CHEMICAL INDUSTRY PARK				
City:	SHANGHAI				
State/Country:	CHINA				
Postal Code:	201507				

# **PROPERTY NUMBERS Total: 1**

Property Type	Number
PCT Number:	CN2017103607

### **CORRESPONDENCE DATA**

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 5714587790

**Email:** patent@gandmpatent.com

Correspondent Name: GRUNEBERG AND MYERS PLLC

Address Line 1: 1775 TYSONS BLVD.

Address Line 2: 5TH FLOOR

Address Line 4: TYSONS, VIRGINIA 22102

ATTORNEY DOCKET NUMBER:	002675USPCT
NAME OF SUBMITTER:	MALIKA ASH SHAKUR
SIGNATURE:	/Malika Ash Shakur/

PAIENI

506088169 REEL: 052821 FRAME: 0927

DATE SIGNED:	06/03/2020					
Total Attachments: 13						
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# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6129457

SUBMISSION TYPE:	NEW ASSIGNMENT				
NATURE OF CONVEYANCE:	ASSIGNMENT				

### **CONVEYING PARTY DATA**

Name	Execution Date
HONG ZHANG	05/14/2020
FEI TENG	05/14/2020
JIANMIN YANG	04/27/2020
ZHISHENG WANG	04/26/2020
YI JHEN HUANG	05/14/2020

### **RECEIVING PARTY DATA**

Name:	EVONIK SPECIALTY CHEMICALS (SHANGHAI) CO., LTD.				
Street Address:	NO. 68 LIANHE ROAD CHEMICAL INDUSTRIAL PARK				
City:	SHANGHAI				
State/Country:	CHINA				
Postal Code:	201507				

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
PCT Number:	CN2017103607

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**Phone:** 5714587790

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Correspondent Name: GRUNEBERG AND MYERS PLLC

Address Line 1: 1775 TYSONS BLVD.

Address Line 2: 5TH FLOOR

Address Line 4: TYSONS, VIRGINIA 22102

ATTORNEY DOCKET NUMBER:	002675USPCT
NAME OF SUBMITTER:	NANCY RILEY
SIGNATURE:	/Nancy Riley/
DATE SIGNED:	05/29/2020
Total Attachments: 12	

2016P00339WOUS

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# ASSIGNMENT

WHEREAS I/We, the below named inventor(s) (hereinafter referred to as ASSIGNOR(S)) have made an invention entitled:

#### TOUGH POLYAMIDE MOULDING MATERIAL

for which an International application was filed on September 27, 2017 and was assigned the Application No. PCT/CN2017/103607; and

WHEREAS, Evonik Specialty Chemicals (Shanghai) Co., Ltd., a corporation of China, whose post office address is No. 68 Lianhe Road

Chemical Industry Park, Shanghai, 201507 Shanghai, China (hereinafter referred to as ASSIGNEE), is desirous of securing the entire right, title, and interest in and to the aforesaid invention and/or any improvements thereon in all countries throughout the world, and in and to the application(s) for Letters Patent on the aforesaid invention and/or any improvements thereon and the Letters Patent to be issued upon the aforesaid U.S. and/or International application(s);

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, ASSIGNOR(S), by these presents do hereby sell, assign and transfer to ASSIGNEE, the full and exclusive right, title and interest in and to the aforesaid invention and any improvements thereon, the aforesaid application(s) and all corresponding and/or counterpart foreign patent applications, all divisional, continuation, continuation-in-part, reissue, reexamination, extension, substitution, registration, renewal, extension, Supplementary Protection Certificates or the like, and any additional patent applications which claim priority to the aforesaid application(s), and all Letters Patent or comparable rights issuing thereon in the United States and in all foreign countries, and all applications for Letters Patent which may hereafter be filed for the aforesaid invention and/or any improvements thereon in the United States and/or in any foreign country and all Letters Patent which may be granted on the aforesaid invention and/or any improvements thereon in the United States and/or in any foreign country, together with the right(s) to claim priority to the aforesaid patent application(s) and/or any improvements thereon, and the ASSIGNOR(S) hereby authorize and request the United States Commissioner of Patents and Trademarks and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent or comparable rights issuing on any application as aforesaid to ASSIGNEE, or to its successors, assigns or legal representatives;

ASSIGNOR(S) hereby covenant that ASSIGNOR(S) have full right to convey the entire interest herein assigned, and that ASSIGNOR(S) have not executed, and will not execute, any agreement in conflict herewith;

ASSIGNOR(S) agree to communicate to ASSIGNEE or to its successors, assigns or legal representatives any and all facts known to them or any of them respecting said invention, and without further remoneration to testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, continuation-in-part, reissue and reexamination applications, make all rightful oaths and generally do all lawful acts to aid ASSIGNEE or its successors, assigns or legal

2016P00339WOUS

representatives to obtain and enforce proper patent protection for said invention in all countries and to enhance or perfect ASSIGNEE's title in and to the invention and patent rights therein.

ASSIGNOR(S) hereby authorize attorneys for ASSIGNEE to enter on this document any applicable serial numbers and filing dates after ASSIGNOR(S') execution of this document.

ASSIGNOR(S) hereby acknowledge an obligation to assign and do hereby assign all right, title and interest in and to the aforesaid invention and any improvements thereon to ASSIGNEE at the time the invention was made.

This Assignment may be executed in one (1) or more counterparts, each of which shall be deemed an original, but all of which together shall constitute one and the same instrument.

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Jianmin YANG

Room 302, Building 16, No. 1111 Lijin Road, Pudong District 200120 Shanghai China

PATENT (10 of 3)
REEL: 052821 FRAME: 0931

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IN TESTIMONY  day of May	WHEREOF,	hereunto	set	my	hand	and	seal	this
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PATENT of 3)
REEL: 052821 FRAME: 0932

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# TOUGH POLYAMIDE MOULDING MATERIAL

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NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, ASSIGNOR(S), by these presents do hereby sell, assign and transfer to ASSIGNEE, the full and exclusive right, title and interest in and to the aforesaid invention and any improvements thereon, the aforesaid application(s) and all corresponding and/or counterpart foreign patent applications, all divisional, continuation, continuation-in-part, reissue, reexamination, extension, substitution, registration, renewal, extension, Supplementary Protection Certificates or the like, and any additional patent applications which claim priority to the aforesaid application(s), and all Letters Patent or comparable rights issuing thereon in the United States and in all foreign countries, and all applications for Letters Patent which may hereafter be filed for the aforesaid invention and/or any improvements thereon in the United States and/or in any foreign country and all Letters Patent which may be granted on the aforesaid invention and/or any improvements thereon in the United States and/or in any foreign country, together with the right(s) to claim priority to the aforesaid patent application(s) and/or any improvements thereon, and the ASSIGNOR(S) hereby authorize and request the United States Commissioner of Patents and Trademarks and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent or comparable rights issuing on any application as aforesaid to ASSIGNEE, or to its successors, assigns or legal representatives;

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2016P00339WOUS

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(Sheet 2 of 3)

2016P00339WOUS

	IN TESTIMONYday of	I hereunto set my hand and seal this
		Fei TENG
		55 Chundong Road Xinzhuang Industry Park 201108 Shanghai China
	IN TESTIMONYday of	I hereunto set my hand and seal this
		Zhisheng WANG
		Room 501, Building 57, Lane 47, West Guilin Road 200233 Shanghai China
	IN TESTIMONYday of	I hereunto set my hand and seal this
dansk	and and	Yi Jhen HUANG
**		7F3, No. 146, Sec. 6, Minquan E. Rd., Neihu
		Dist. 114-Taiper City Taiwan

(Sheet 3 of 3)

2016P00339WOUS

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(Sheet 1 of 3)

2016P00339WOUS

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IN TESTIMONY day of	• •	I hereunto set my hand and seal this
		Hong ZHANG 55 Chundong Road
		Xinzhuang Industrial Park 201108 Shanghai China
 IN TESTIMONY day of	· ·	I hereunto set my hand and seal this
		Jianmin YANG
		Room 302, Building 16, No. 1111 Lijin Road, Pudong District 200120 Shanghai

China

(Sheet 2 of 3)

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IN	TESTIMONY day of				set	my	hand	and	seal	this
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(Sheet 3 of 3)

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PATENSTreet 1 of 3)
REEL: 052821 FRAME: 0939

2016P00339WOUS

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 IN TESTIMONY day of	· ·		hereunto	set	my	hand	and	seal	this
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Jianmin YANG

Room 302, Building 16, No. 1111 Lijin Road, Pudong District 200120 Shanghai China

PATENTE (2 of 3)
REEL: 052821 FRAME: 0940

2016P00339WOUS

IN TESTIMONY day of				set	my	hand	and	seal	this
		Fe	i TENG						
		Xi 20	Chundong nzhuang Ind 1108 Shang nina	dustry	Park				
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**RECORDED: 06/03/2020**